## HAT2053M

Silicon N Channel Power MOS FET Power Switching

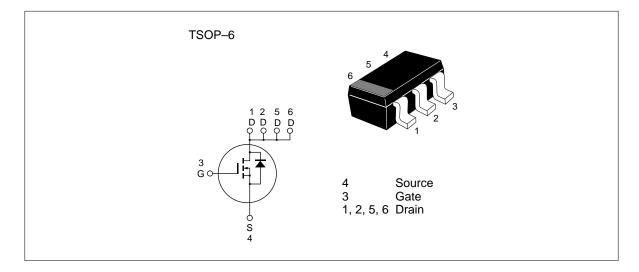
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ADE-208-755B(Z) Preliminary, 3rd. Edition Dec. 1, 1998

### Features

- Low on-resistance
- Low drive current
- High density mounting
- 2.5V gate drive device can be driven from 3V source

#### Outline



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## **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±12	V
Drain current	I <sub>D</sub> * <sup>2</sup>	6.1	A
Drain peak current	L *1 D(pulse)	24.4	А
Body-drain diode reverse drain current	*2 DR	6.1	A
Channel dissipation	Pch <sub>(pulse)</sub> * <sup>2</sup>	2.0	W
	Pch <sub>(continuous)</sub> * <sup>3</sup>	1.05	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150 °C	

Notes: 1.  $PW \le 10\mu s$ , duty cycle  $\le 1 \%$ 

2. When using the alumina ceramic board (50 x 50 x 0.7 mm), PW $\leq$  5s,Ta=25°C

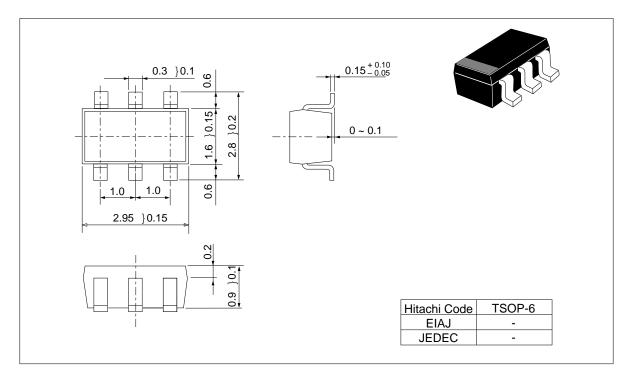
3. When using the alumina ceramic board (50 x 50 x 0.7 mm) ,Ta= $25^{\circ}C$ 

### **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	20	_	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 12V, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	0.4	_	1.4	V	$V_{DS} = 10V, I_{D} = 1mA$
Static drain to source on state	$R_{DS(on)}$	_	28	33	mΩ	$I_{\rm D} = 3$ A, $V_{\rm GS} = 4.5$ V * <sup>1</sup>
resistance	R <sub>DS(on)</sub>		37	48	mΩ	$I_{\rm D} = 3A, V_{\rm GS} = 2.5V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	6.5	11	_	S	$I_{\rm D} = 3A, V_{\rm DS} = 10V^{*1}$
Input capacitance	Ciss	_	570		pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	220	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	160	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	15	_	ns	$V_{GS} = 4.5V, I_{D} = 3A$
Rise time	t,		100		ns	$R_{L} = 3.3\Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	90	_	ns	_
Fall time	t <sub>f</sub>		105		ns	_
Body-drain diode forward voltage	V <sub>DF</sub>	_	0.95	_	V	$IF = 6.1A, V_{GS} = 0^{*1}$
Body–drain diode reverse recovery time	t <sub>rr</sub>		(50)		ns	$\label{eq:IF} \begin{array}{l} IF=6.1A,V_{_{\mathrm{GS}}}=0\\ diF/dt=\!20A/\mus \end{array}$

Note: 1. Pulse test

## Package Dimensions (Unit: mm)



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